

## High Performance 1A LDO

### ISL80101

The ISL80101 is a low voltage, high current, single output LDO specified at 1A output current. This LDO operates from input voltages of 2.2V to 6V. Fixed output voltage options are available in 1.8V, 2.5V, 3.3V and 5.0V versions. Other custom voltage options are available upon request. For the adjustable output version of the ISL80101, please refer to the [ISL80101-ADJ](#) datasheet.

A sub-micron BiCMOS process is utilized for this product family to deliver the best in class analog performance and overall value. This CMOS LDO consumes significantly lower quiescent current as a function of load compared to bipolar LDOs, which translates into higher efficiency and packages with smaller footprints. State of the art internal compensation achieves a very fast load transient response. An external capacitor on the soft-start pin provides an adjustable soft-starting ramp. The ENABLE feature allows the part to be placed into a low quiescent current shutdown mode. A Power-Good logic output signals a fault condition.

Table 1 shows the differences between the ISL80101 and others in its family:

TABLE 1. KEY DIFFERENCES BETWEEN FAMILY OF PARTS

PART NUMBER	PROGRAMMABLE I <sub>LIMIT</sub>	I <sub>LIMIT</sub> (DEFAULT)	ADJ or FIXED V <sub>OUT</sub>
ISL80101-ADJ	No	1.75A	ADJ
ISL80101	No	1.75A	1.8V, 2.5V, 3.3V, 5.0V
ISL80101A	Yes	1.62A	ADJ
ISL80121-5	Yes	0.75A	5.0V

### Features

- $\pm 0.2\%$  Initial V<sub>OUT</sub> Accuracy
- $\pm 1.8\%$  V<sub>OUT</sub> Accuracy Guaranteed Over Line, Load and T<sub>J</sub> = -40°C to +125°C
- Very Low 130mV Dropout Voltage at V<sub>OUT</sub> = 2.5V
- Very Fast Transient Response
- Programmable Soft-starting
- Power-Good Output
- Excellent 58dB PSRR at 1kHz
- Current Limit Protection
- Thermal Shutdown Function
- Available in a 10 Ld DFN Package
- Pb-Free (RoHS Compliant)

### Applications

- DSP, FPGA and  $\mu$ P Core Power Supplies
- Noise-Sensitive Instrumentation Systems
- Post Regulation of Switched Mode Power Supplies
- Industrial Systems
- Medical Equipment
- Telecommunications and Networking Equipment
- Servers
- Hard Disk Drives (HD/HDD)

### Related Literature

- See [AN1592](#), "ISL80101 High Performance 1A LDO Evaluation Board User Guide"

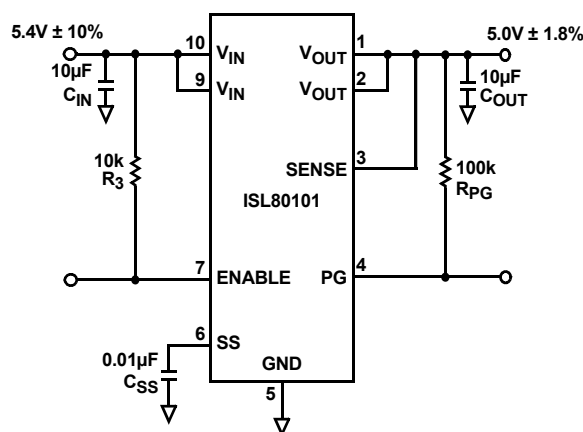


FIGURE 1. TYPICAL APPLICATION CIRCUIT

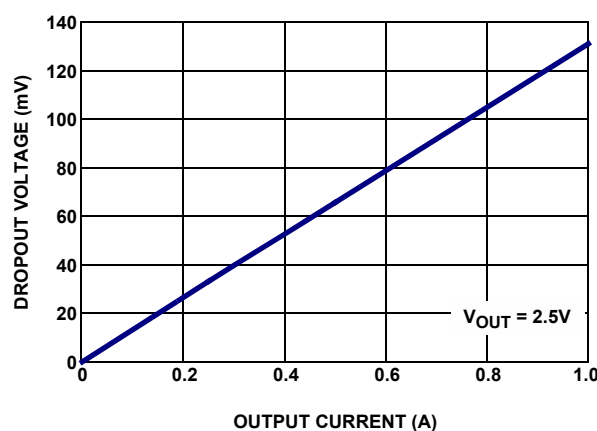
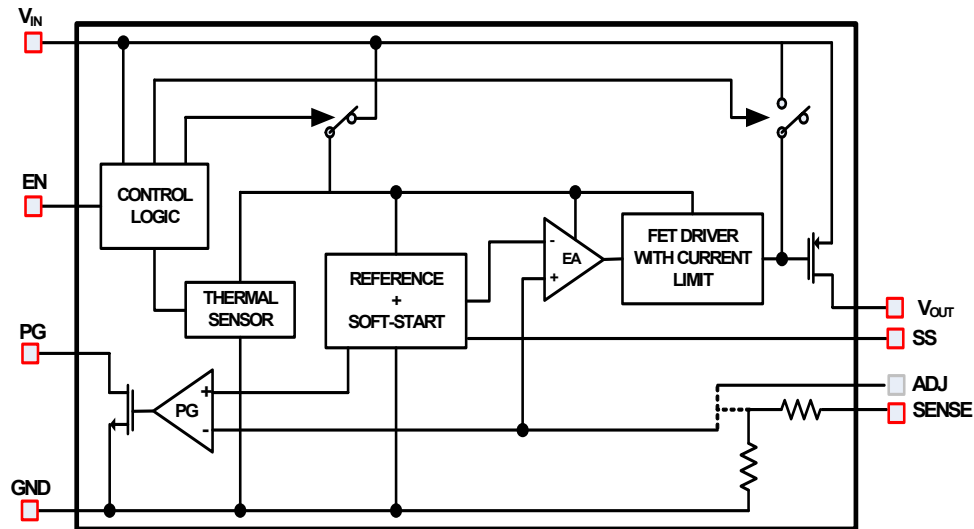


FIGURE 2. DROPOUT vs LOAD CURRENT

## Block Diagram



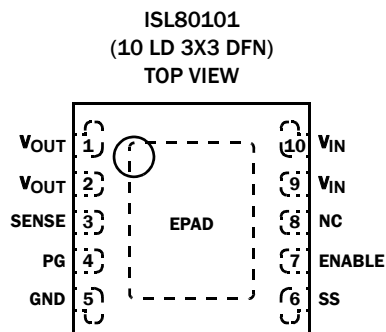
## Ordering Information

PART NUMBER (Notes 1, 3, 4)	PART MARKING	V <sub>OUT</sub> VOLTAGE (Note 2)	TEMP RANGE (°C)	PACKAGE (Pb-Free)	PKG DWG. #
ISL80101IR18Z	DZEB	1.8V	-40 to +125	10 Ld 3x3 DFN	L10.3x3
ISL80101IR25Z	DZFB	2.5V	-40 to +125	10 Ld 3x3 DFN	L10.3x3
ISL80101IR33Z	DZGB	3.3V	-40 to +125	10 Ld 3x3 DFN	L10.3x3
ISL80101IR50Z	DZHB	5.0V	-40 to +125	10 Ld 3x3 DFN	L10.3x3
ISL80101EVAL2Z	Evaluation Board				

### NOTES:

1. Add "-T\*" for Tape and Reel. Please refer to [TB347](#) for details on reel specifications.
2. For other output voltages, contact Intersil Marketing.
3. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
4. For Moisture Sensitivity Level (MSL), please see device information page for [ISL80101](#). For more information on MSL please see Technical Brief [TB363](#).

## Pin Configurations



## Pin Descriptions

PIN NUMBER	PIN NAME	DESCRIPTION
1, 2	V <sub>OUT</sub>	Regulated output voltage. A minimum 10μF X5R/X7R output capacitor is required for stability. See “External Capacitor Requirements” on page 8 for more details.
3	SENSE	The PGOOD circuit uses this input to monitor the output voltage status, providing a remote voltage sense.
4	PG	This is an open drain logic output used to indicate the status of the output voltage. Logic low indicates V <sub>OUT</sub> is not in regulation. This pin must be grounded if not used.
5	GND	Ground.
6	SS	External capacitor on this pin adjusts startup ramp and controls inrush current.
7	ENABLE	V <sub>IN</sub> independent chip enable. TTL and CMOS compatible.
8	NC	No connection. Leave floating.
9, 10	V <sub>IN</sub>	Input supply. A minimum of 10μF X5R/X7R input capacitor is required for proper operation. See “External Capacitor Requirements” on page 8 for more details.
-	EPAD	EPAD at ground potential. It is recommended to solder the EPAD to the ground plane.

## Absolute Maximum Ratings

$V_{IN}$ Relative to GND (Note 5)	-0.3V to +6.5V
$V_{OUT}$ Relative to GND (Note 5)	-0.3V to +6.5V
PG, ENABLE, SENSE, SS	
Relative to GND (Note 5)	-0.3V to +6.5V
ESD Rating	
Human Body Model (Tested per JESD22 A114F)	2.5kV
Machine Model (Tested per JESD22 A115C)	250V
Latch Up (Tested per JESD78C, Class 2, Level A)	$\pm 100\text{mA}$ at +85°C

## Thermal Information

Thermal Resistance (Typical)	$\theta_{JA}$ (°C/W)	$\theta_{JC}$ (°C/W)
10 Ld DFN Package (Notes 6, 7)	48	7
Storage Temperature Range	-65°C to +150°C	
Junction Temperature	+150°C	
Pb-Free Reflow Profile	see link below <a href="http://www.intersil.com/pbfree/Pb-FreeReflow.asp">http://www.intersil.com/pbfree/Pb-FreeReflow.asp</a>	

## Recommended Operating Conditions (Notes 8, 9)

Junction Temperature Range (TJ) (Note 8)	-40°C to +125°C
$V_{IN}$ Relative to GND	2.2V to 6V
$V_{OUT}$ Range	800mV to 5V
PG, ENABLE, SENSE/ADJ, SS relative to GND	0V to 6V
PG Sink Current	<10mA

**CAUTION:** Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

### NOTES:

- Absolute maximum voltage rating is defined as the voltage applied for a lifetime average duty cycle above 6V of 1%.
- $\theta_{JA}$  is measured in free air with the component mounted on a high effective thermal conductivity test board with "direct attach" features. See Tech Brief [TB379](#).
- For  $\theta_{JC}$ , the "case temp" location is the center of the exposed metal pad on the package underside.
- Extended operation at these conditions may compromise reliability. Exceeding these limits will result in damage. Recommended operating conditions define limits where specifications are guaranteed.
- Electromigration specification defined as lifetime average junction temperature of +110°C where max rated DC current = lifetime average current.

**Electrical Specifications** Unless otherwise noted,  $V_{IN} = V_{OUT} + 0.4\text{V}$ ,  $V_{OUT} = 1.8\text{V}$ ,  $C_{IN} = C_{OUT} = 2.2\mu\text{F}$ ,  $T_J = +25^\circ\text{C}$ . Applications must follow thermal guidelines of the package to determine worst case junction temperature. Please refer to "Applications Information" on page 8 and Tech Brief [TB379](#). **Boldface limits apply over the operating temperature range, -40°C to +125°C.**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 10)	TYP	MAX (Note 10)	UNITS
<b>DC CHARACTERISTICS</b>						
DC Output Voltage Accuracy	$V_{OUT}$	$V_{OUT} + 0.4\text{V} < V_{IN} < 6\text{V}$ , $0\text{A} < I_{LOAD} < 1\text{A}$	<b>-1.8</b>		<b>1.8</b>	%
DC Input Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN}}$	$V_{OUT} + 0.4\text{V} < V_{IN} < 6\text{V}$			<b>1</b>	%
DC Output Load Regulation	$\frac{\Delta V_{OUT}}{\Delta I_{OUT}}$	$0\text{A} < I_{LOAD} < 1\text{A}$ , All voltage options	<b>-1</b>			%
Ground Pin Current	$I_Q$	$I_{LOAD} = 0\text{A}$ , $2.2\text{V} < V_{IN} < 6\text{V}$		3	<b>5</b>	mA
		$I_{LOAD} = 1\text{A}$ , $2.2\text{V} < V_{IN} < 6\text{V}$		5	<b>7</b>	mA
Ground Pin Current in Shutdown	$I_{SHDN}$	ENABLE Pin = 0.2V, $V_{IN} = 6\text{V}$		0.2	<b>12</b>	$\mu\text{A}$
Dropout Voltage (Note 11)	$V_{DO}$	$I_{LOAD} = 1\text{A}$ , $V_{OUT} = 2.5\text{V}$		130	<b>212</b>	mV
Output Short Circuit Current	OCP	$V_{OUT} = 0\text{V}$ , $2.2\text{V} < V_{IN} < 6\text{V}$		1.75		A
Thermal Shutdown Temperature	TSD	$2.2\text{V} < V_{IN} < 6\text{V}$		160		°C
Thermal Shutdown Hysteresis (Rising Threshold)	TSDn	$2.2\text{V} < V_{IN} < 6\text{V}$		30		°C
<b>AC CHARACTERISTICS</b>						
Input Supply Ripple Rejection	PSRR	$f = 1\text{kHz}$ , $I_{LOAD} = 1\text{A}$ ; $V_{IN} = 2.2\text{V}$		58		dB
		$f = 120\text{Hz}$ , $I_{LOAD} = 1\text{A}$ ; $V_{IN} = 2.2\text{V}$		72		dB
Output Noise Voltage		$I_{LOAD} = 1\text{A}$ , $\text{BW} = 10\text{Hz} < f < 100\text{kHz}$		63		$\mu\text{V}_{\text{RMS}}$
<b>ENABLE PIN CHARACTERISTICS</b>						
Turn-on Threshold		$2.2\text{V} < V_{IN} < 6\text{V}$	<b>0.3</b>	0.8	<b>1</b>	V
Hysteresis (Rising Threshold)		$2.2\text{V} < V_{OUT} + 0.4\text{V} < 6\text{V}$	<b>10</b>	80	<b>200</b>	mV

# ISL80101

**Electrical Specifications** Unless otherwise noted,  $V_{IN} = V_{OUT} + 0.4V$ ,  $V_{OUT} = 1.8V$ ,  $C_{IN} = C_{OUT} = 2.2\mu F$ ,  $T_J = +25^\circ C$ . Applications must follow thermal guidelines of the package to determine worst case junction temperature. Please refer to “Applications Information” on page 8 and Tech Brief [TB379](#). **Boldface limits apply over the operating temperature range,  $-40^\circ C$  to  $+125^\circ C$ .** (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 10)	TYP	MAX (Note 10)	UNITS
ENABLE Pin Turn-on Delay		$C_{OUT} = 10\mu F$ , $I_{LOAD} = 1A$		100		$\mu s$
ENABLE Pin Leakage Current		$V_{IN} = 6V$ , ENABLE = 3V			<b>1</b>	$\mu A$
<b>SOFT-START CHARACTERISTICS</b>						
SS Pin Currents (Note 11)	IPD	$V_{IN} = 3.5V$ , ENABLE = 0V, SS = 1V	<b>0.5</b>	1	<b>1.3</b>	mA
	ICHG		<b>-3.3</b>	-2	<b>-0.8</b>	$\mu A$
<b>PG PIN CHARACTERISTICS</b>						
$V_{OUT}$ PG Flag Threshold			<b>75</b>	85	<b>92</b>	% $V_{OUT}$
$V_{OUT}$ PG Flag Hysteresis				4		%
PG Flag Low Voltage		$V_{IN} = 2.5V$ , $I_{SINK} = 500\mu A$			<b>100</b>	mV
PG Flag Leakage Current		$V_{IN} = 6V$ , PG = 6V			<b>1</b>	$\mu A$

**NOTES:**

10. Parameters with MIN and/or MAX limits are 100% tested at  $+25^\circ C$ , unless otherwise specified. Temperature limits established by characterization and are not production tested.
11. Dropout is defined as the difference in supply  $V_{IN}$  and  $V_{OUT}$  when the output is below its nominal regulation..

## Typical Operating Performance

Unless otherwise noted:  $V_{IN} = 2.2V$ ,  $V_{OUT} = 1.8V$ ,  $C_{IN} = C_{OUT} = 10\mu F$ ,  $T_J = +25^\circ C$ ,  $I_L = 0A$ .

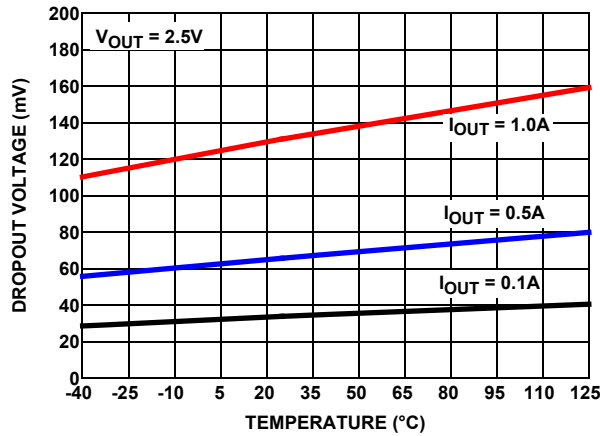


FIGURE 3. DROPOUT vs TEMPERATURE

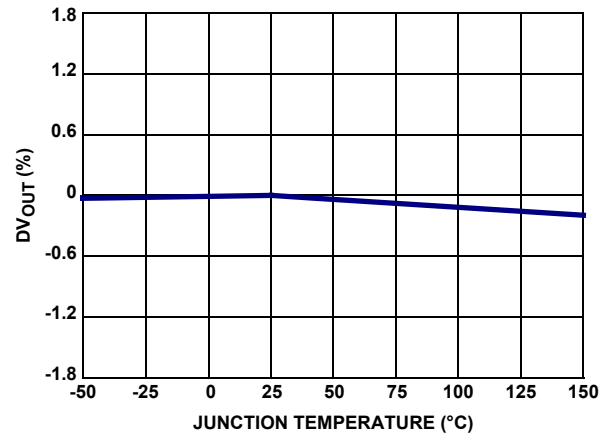


FIGURE 4.  $V_{OUT}$  vs TEMPERATURE

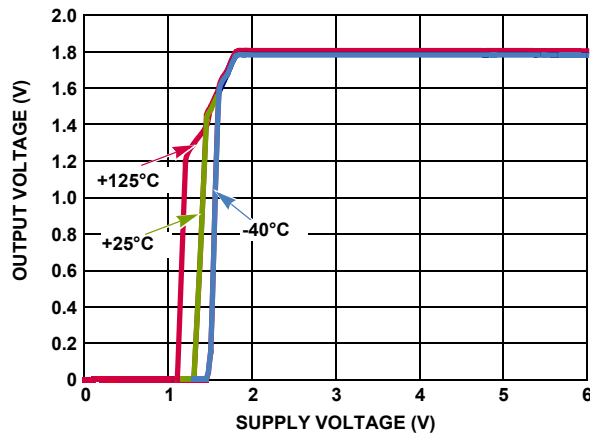


FIGURE 5. OUTPUT VOLTAGE vs SUPPLY VOLTAGE

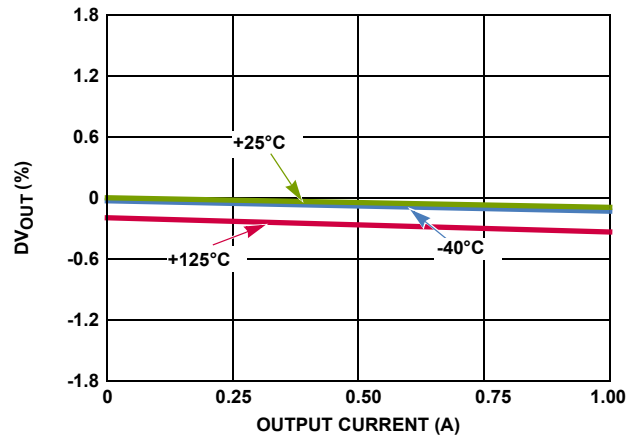


FIGURE 6. OUTPUT VOLTAGE vs OUTPUT CURRENT

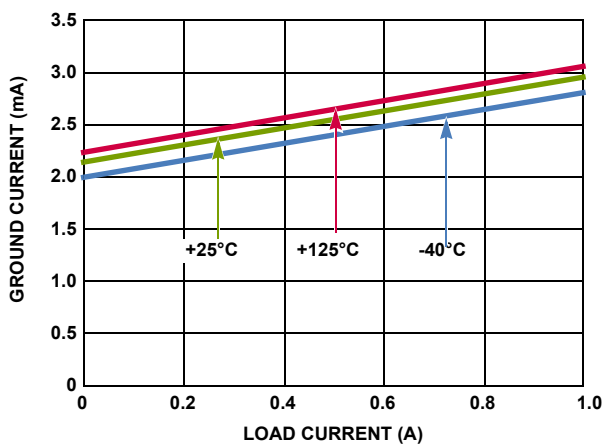


FIGURE 7. GROUND CURRENT vs LOAD CURRENT

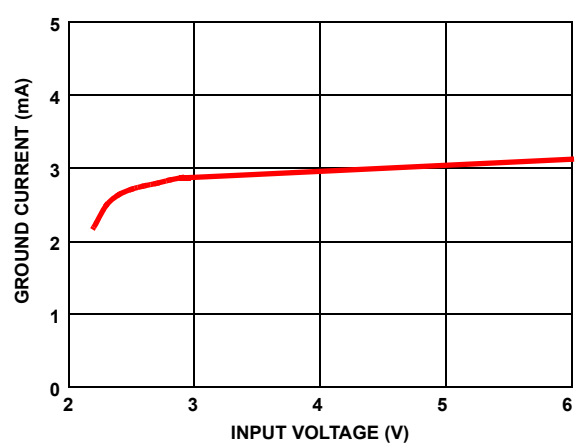


FIGURE 8. GROUND CURRENT vs SUPPLY VOLTAGE

## Typical Operating Performance

Unless otherwise noted:  $V_{IN} = 2.2V$ ,  $V_{OUT} = 1.8V$ ,  $C_{IN} = C_{OUT} = 10\mu F$ ,  $T_J = +25^\circ C$ ,  $I_L = 0A$ . (Continued)

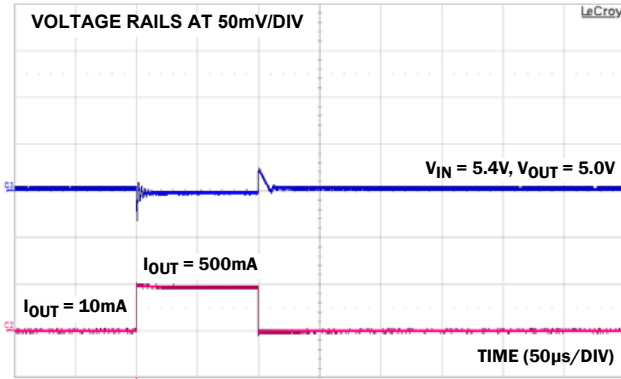


FIGURE 9A.

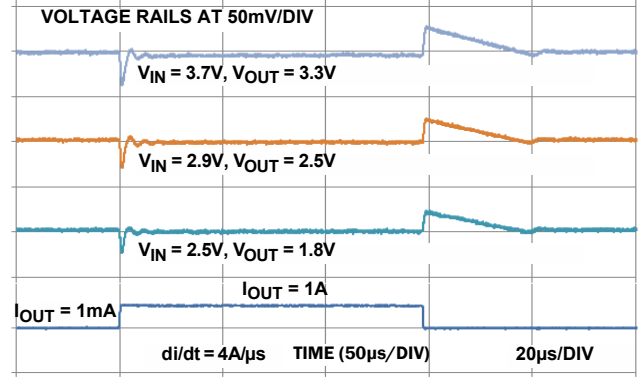


FIGURE 9B.

FIGURE 9. LOAD TRANSIENT RESPONSE

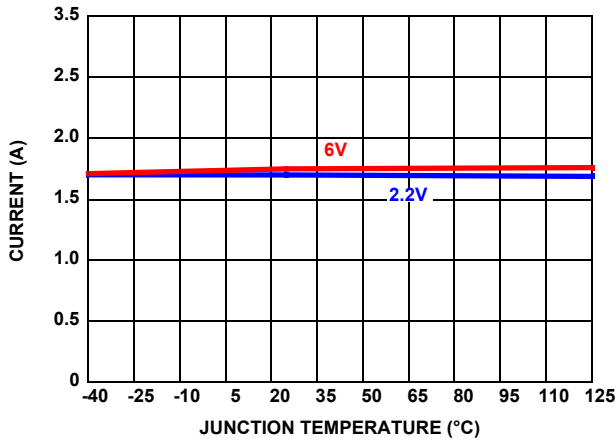


FIGURE 10. CURRENT LIMIT vs TEMPERATURE ( $V_{OUT} = 0V$ )

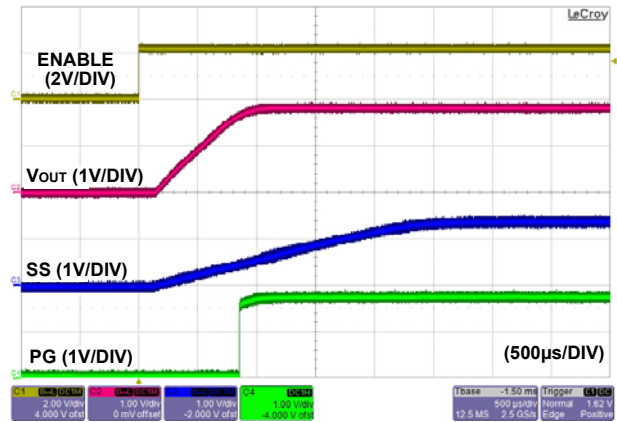


FIGURE 11. ENABLE START-UP ( $C_{SS} = 2.2nF$ )

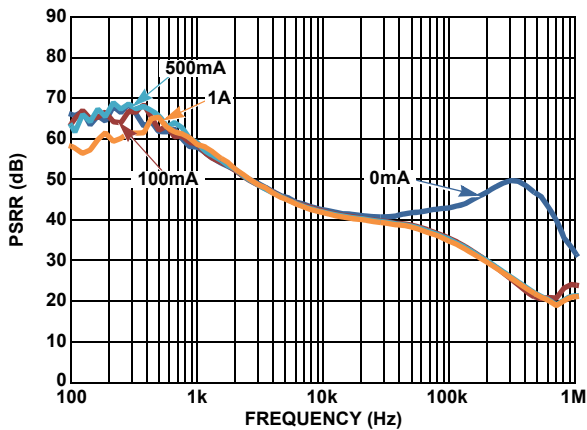


FIGURE 12. PSRR vs FREQUENCY AND LOAD CURRENT

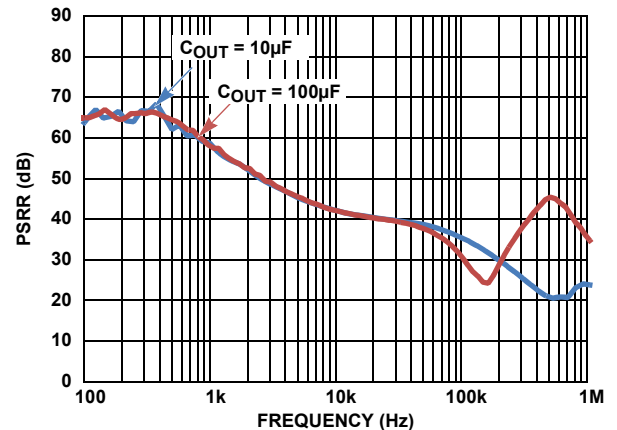


FIGURE 13. PSRR vs FREQUENCY AND OUTPUT CAPACITANCE ( $I_{OUT} = 100mA$ )

## Typical Operating Performance

Unless otherwise noted:  $V_{IN} = 2.2V$ ,  $V_{OUT} = 1.8V$ ,  $C_{IN} = C_{OUT} = 10\mu F$ ,  $T_J = +25^\circ C$ ,  $I_L = 0A$ . (Continued)

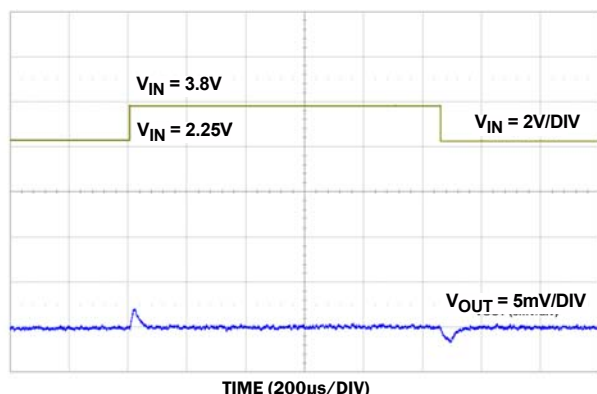


FIGURE 14. LINE TRANSIENT RESPONSE

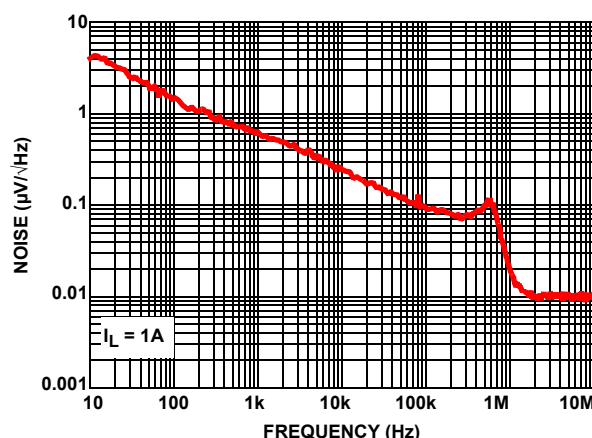


FIGURE 15. OUTPUT NOISE SPECTRAL DENSITY

## Applications Information

### Input Voltage Requirements

The ISL80101 is capable of delivering the following fixed output voltages: 1.8V, 2.5V, 3.3V, 5.0V. Due to the nature of an LDO,  $V_{IN}$  must be some margin higher than  $V_{OUT}$  plus dropout at the maximum rated current of the application if active filtering (PSRR) is expected from  $V_{IN}$  to  $V_{OUT}$ . The generous dropout specification of this family of LDOs allows applications to design a level of efficiency.

### Enable Operation

The ENABLE turn-on threshold is typically 800mV with 80mV of hysteresis. An internal pull-up or pull-down resistor to change these values is available upon request. As a result, this pin must not be left floating, and should be tied to  $V_{IN}$  if not used. A 1kΩ to 10kΩ pull-up resistor is required for applications that use open collector or open drain outputs to control the ENABLE pin. The ENABLE pin may be connected directly to  $V_{IN}$  for applications with outputs that are always on.

### Power-Good Operation

PG is a logic output that indicates the status of  $V_{OUT}$  and  $V_{IN}$ . The PG flag is an open-drain NMOS that can sink up to 10mA during a fault condition. The PG pin requires an external pull-up resistor typically connected to the  $V_{OUT}$  pin. The PG pin should not be pulled up to a voltage source greater than  $V_{IN}$ . PG goes low when the output voltage drops below 84% of the nominal output voltage or if the part is disabled. PG functions during current limit and thermal shutdown. For applications not using this feature, connect this pin to ground.

### Soft-Start Operation

The soft-start circuit controls the rate at which the output voltage rises up to regulation at power-up or LDO enable. This start-up ramp time can be set by adding an external capacitor from the SS pin to ground. An internal 2μA current source charges up this

$C_{SS}$  and the feedback reference voltage is clamped to the voltage across it. The start-up time is set by Equation 1.

$$t_{start} = \frac{C_{SS} \times 0.5}{2\mu A} \quad (EQ. 1)$$

Equation 2 determines the  $C_{SS}$  required for a specific start-up in-rush current, where  $V_{OUT}$  is the output voltage,  $C_{OUT}$  is the total capacitance on the output and  $I_{INRUSH}$  is the desired in-rush current.

$$C_{SS} = \frac{V_{OUT} \times C_{OUT} \times 2\mu A}{I_{INRUSH} \times 0.5V} \quad (EQ. 2)$$

The external capacitor is always discharged to ground at the beginning of start-up or enabling.

### External Capacitor Requirements

External capacitors are required for proper operation. Careful attention must be paid to the layout guidelines and selection of capacitor type and value to ensure optimal performance.

#### OUTPUT CAPACITOR

The ISL80101 applies state-of-the-art internal compensation to keep the selection of the output capacitor simple for the customer. Stable operation over full temperature,  $V_{IN}$  range,  $V_{OUT}$  range and load extremes are guaranteed for all capacitor types and values assuming a minimum of 10μF X5R/X7R is used for local bypass on  $V_{OUT}$ . This output capacitor must be connected to the  $V_{OUT}$  and GND pins of the LDO with PCB traces no longer than 0.5cm.

There is a growing trend to use very-low ESR multilayer ceramic capacitors (MLCC) because they can support fast load transients and also bypass very high frequency noise from other sources. However, the effective capacitance of MLCCs drops with applied voltage, age, and temperature. X7R and X5R dielectric ceramic capacitors are strongly recommended as they typically maintain a capacitance range within  $\pm 20\%$  of nominal voltage over full operating ratings of temperature and voltage.



Additional capacitors of any value in ceramic, POSCAP, alum/tantalum electrolytic types may be placed in parallel to improve PSRR at higher frequencies and/or load transient AC output voltage tolerances.

## INPUT CAPACITOR

For proper operation, a minimum capacitance of 10µF X5R/X7R is required at the input. This ceramic input capacitor must be connected to the  $V_{IN}$  and GND pins of the LDO with PCB traces no longer than 0.5cm.

## Power Dissipation and Thermals

The junction temperature must not exceed the range specified in the “Recommended Operating Conditions (Notes 8, 9)” on page 4. The power dissipation can be calculated by using Equation 3:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND} \quad (\text{EQ. 3})$$

The maximum allowable junction temperature,  $T_{J(MAX)}$  and the maximum expected ambient temperature,  $T_{A(MAX)}$  determine the maximum allowable power dissipation, as shown in Equation 4:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA} \quad (\text{EQ. 4})$$

$\theta_{JA}$  is the junction-to-ambient thermal resistance.

For safe operation, ensure that the power dissipation  $P_D$ , calculated from Equation 3, is less than the maximum allowable power dissipation  $P_{D(MAX)}$ .

The DFN package uses the copper area on the PCB as a heat-sink. The EPAD of this package must be soldered to the copper plane (GND plane) for effective heat dissipation. Figure 16 shows a curve for the  $\theta_{JA}$  of the DFN package for different copper area sizes.

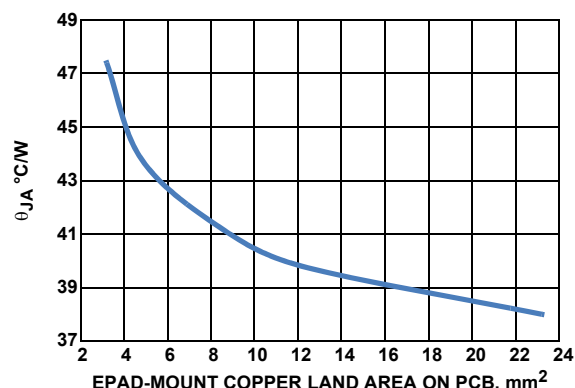


FIGURE 16. 3mmx3mm-10 PIN DFN ON 4-LAYER PCB WITH THERMAL VIAS  $\theta_{JA}$  vs EPAD-MOUNT COPPER LAND AREA ON PCB

## Thermal Fault Protection

The power level and the thermal impedance of the package (+45° C/W for DFN) determine when the junction temperature exceeds the thermal shutdown temperature. In the event that the die temperature exceeds around +160°C, the output of the LDO will shut down until the die temperature cools down to about +130°C.

## Current Limit Protection

The ISL80101 LDO incorporates protection against overcurrent due to any short or overload condition applied to the output pin. The LDO performs as a constant current source when the output current exceeds the current limit threshold noted in the “Electrical Specifications” table on page 4. If the short or overload condition is removed from  $V_{OUT}$ , then the output returns to normal voltage regulation mode. In the event of an overload condition, the LDO may begin to cycle on and off due to the die temperature exceeding thermal fault condition and subsequently cooling down after the power device is turned off.

## Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest revision.

DATE	REVISION	CHANGE
7/27/11	FN6931.1	Added Related Literature
7/20/11		<p>Main change - Deleted Adjustable Output Voltage Option Version from datasheet, now only refers to fixed output voltage option includes removal of all graphics referring to Adjustable voltage option.</p> <p>Modified page 1 by adding Table of key differences, graphics and changes to text</p> <p>page 2 - Updated Ordering Information by:</p> <p>Removing ADJ Device ISL80101IRAJZ plus Eval boards.</p> <p>Updated Tape and Reel Note by changing "Add "-T" or "TK"..." to "Add "T*"..."</p> <p>Updated Abs Max Rating and Thermal Information by adding ESD ratings and Latchup</p> <p>Changed 10 Ld DFN Tja and Tjc from "45, 4" to "48, 7"</p> <p>Updated DC Output Voltage Accuracy by combining Vout options</p> <p>Removed Feedback Pin (Adj Option Only), Feedback Input Current Specs</p> <p>Removed "(1A Version)" from Output Short circuit Current Spec</p> <p>Removed Adjustable In-Rush Current Limit Characteristics and replaced with Soft-Start Characteristics</p> <p>page 5 - Electrical Spec Note changed from "Compliance to datasheet limits is assured by one or more methods: production test, characterization and/or design." To "Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested."</p> <p>Complete Rewrite of Applications Information</p> <p>POD L10.3x3 Changed Note 4 from "Dimension b applies..." to "Lead width applies..."</p> <p>Changed Note callout in Detail X from 4 to 5</p> <p>Changed height in side view from 0.90 MAX to 1.00 MAX</p> <p>Added Note 4 callout next to lead width in Bottom View</p> <p>In Land Pattern, corrected lead shape for 4 corner pins to "L" shape (was rectangular and did not match bottom view)</p>
12/21/2009	FN6931.0	Initial Release.

## Products

Intersil Corporation is a leader in the design and manufacture of high-performance analog semiconductors. The Company's products address some of the industry's fastest growing markets, such as, flat panel displays, cell phones, handheld products, and notebooks. Intersil's product families address power management and analog signal processing functions. Go to [www.intersil.com/products](http://www.intersil.com/products) for a complete list of Intersil product families.

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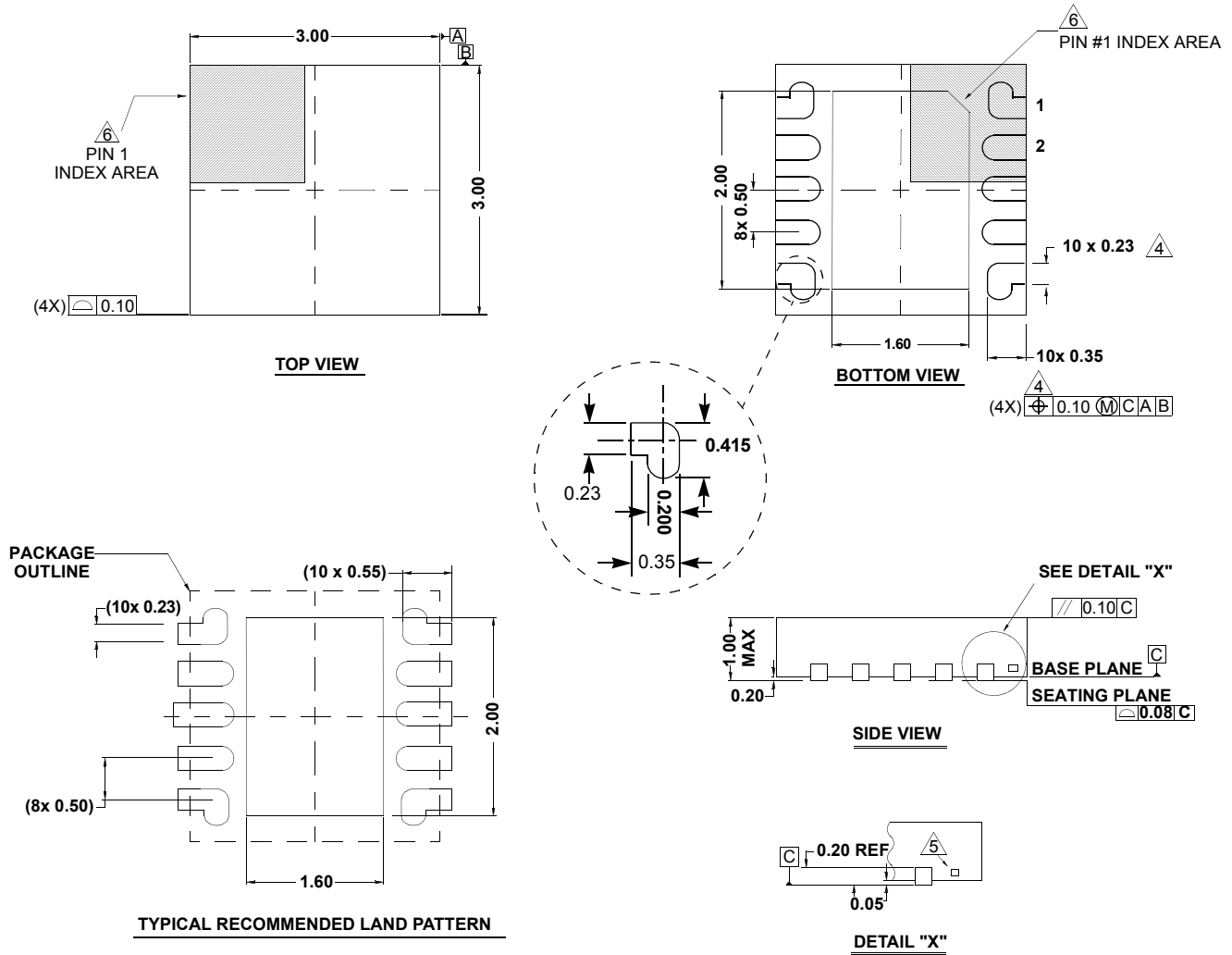
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## Package Outline Drawing

### L10.3x3

10 LEAD DUAL FLAT PACKAGE (DFN)

Rev 6, 09/09



#### NOTES:

1. Dimensions are in millimeters.  
Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal  $\pm 0.05$
4. Lead width applies to the metallized terminal and is measured between 0.18mm and 0.30mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.